

Get a Quote

Overview

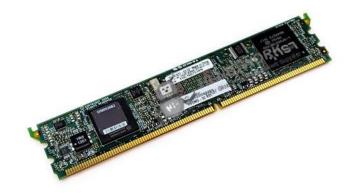
The PVDM3 brings new rich-media capabilities to Cisco® Unified Communications Solutions. High-density voice connectivity. Conferencing, transcoding, and transrating. Management of voice quality. Power savings, secure voice, and more. The module resides on the Cisco 2900 and 3900 Series routers to enable these capabilities. The next-generation high-density packet voice digital-signal-processor (DSP) modules are available in six densities: PVDM3-16, PVDM3-32, PVDM3-64, PVDM3-128, PVDM3-192, and PVDM3-256. The modules have 16, 32, 64, 128, 192, and 256 channels, respectively.

Quick Specification

Product Code	PVDM3-64	
Description	64-channel high-density voice DSP module	
Maximum Number of Channels in Low-Complexity Codecs	64	
Maximum Number of Channels in Medium-Complexity Codecs	42	
Maximum Number of Channels in High-Complexity Codecs	28	
Platform Support	Cisco 2901, 2911, 2921, 2951, 3925, 3945, 3925-E, and 3945-E Integrated Service Routers	
Availability	Unified Communications License on Universal Cisco IOS Software image	
Release	Cisco IOS Software Release 15.0(1)M	

Product Details:

The Front Panel:







Accessories for PVDM3-64:

Compare to Similar Items:

Product Code	PVDM3-16	PVDM3-32	PVDM3-64	PVDM3-128	PVDM3-192	PVDM3-256
	16-channel	32-channel	64-channel	128-channel	192-channel	256-channel
Description	high-density	high-density	high-density	high-density	high-density	high-density
Description	Description voice DSP	voice DSP	voice DSP	voice DSP	voice DSP	voice DSP
	module	module	module	module	module	module
Maximum Number						
of Channels in	16	32	64	128	192	256
Low-Complexity						
Codecs						
Maximum Number						
of Channels in	12	21	42	96	138	192
Medium-						
Complexity Codecs						
Maximum Number						
of Channels in	10	14	28	60	88	120
High-Complexity	10	14	28	δU	88	120
Codecs						

Get more information:

Do you have any question about the PVDM3-64?

Contact us now via e-mail: info@hi-network.com

Specific Data Sheet:

Product Number	PVDM3-64	
Components		
DSP	Multicore DSP technology	
DSP external memory	512-megabit double-data-rate (DDR) synchronous dynamic random access memory (SDRAM) for each DSP	
Interface	240-pin dual-inline-memory-module (DIMM) interface	
Features		
Echo cancellation	Software echo cancellation compliant with ITU-T G.168, with 128-ms tail coverage	
Operating temperature	-41 to 131°F (-5 to 55°C)	
Voltage	3.3V	
Current	1.47A	



PVDM3-64 Datasheet



	\$7			
Power	4.85W			
Regulatory and Compliance				
Safety	 Complies with IEC 60950 (worldwide) and AS/NZS 60950-1 (Australia and New Zealand), CAN/CSA C22.2 No. 60950-1, 1st and 2nd Ed. (Canada), and GB4943-95 (People's Republic of China) EN60950-1, 1st and 2nd Ed. (CENELEC; includes EU and EFTA) NOM-019-SCFI-1998 (Mexico), and UL 60950-1, 1st and 2nd Ed. (United States) 			
Homologation	Platform dependent			
Mean time between failure (MTBF)	System dependent			
EMC				
Emissions	 CISPR22, Class B EN55022, Class B, CFR47, Part 15, Subpart B, Class B 			
Harmonics	EN61000-3-2			
Flicker	EN61000-3-3			
Immunity	 CISPR24 EN 55024 EN50082-1 			
Electrostatic discharge (ESD)	EN 61000-4-2			
RF fields	EN 61000-4-3			
EFT	EN 61000-4-4			
Surge	EN 61000-4-5			
Conducted RF	EN 61000-4-6			
Power-frequency magnetic fields	EN 6100-4-8			
Voltage dips, sags, and interruptions	EN 61000-4-11			
	<u> </u>			





Want to Buy

Get a Quote









Learn More about Hi-Network

Search our Resource Library

Follow us on LinkedIn

Contact for Sales or Support

Contact HI-NETWORK.COM For Global Fast Shipping

HongKong Office Tel: +00852-66181601

HangZhou Office Tel: +0086-571-86729517

Email: info@hi-network.com

Skype: echo.hinetwork

WhatsApp Business: +8618057156223

